

ABSTRACT OF DISCLOSURE

A system for providing a circuit device having no support substrate and which covers and supports a circuit element by an insulating resin. A device manufacturer and a part manufacturer are connected to an ISB server via the Internet. The user (device manufacturer) inputs conditions to be satisfied by a desired ISB through a user terminal and transmits these specifications to the ISB server via the Internet. The ISB server accumulatively stores the received specifications and provides manufacturing data, for example, mask data and part arrangement data for manufacturing an ISB based on the received specifications, to an ISB mounting factory. The ISB mounting factory manufactures an ISB based on the supplied manufacturing data and provides the ISB to the user. A part manufacturer supplies, via the Internet, data of a part which can be used in an ISB and registers the part data in a database.